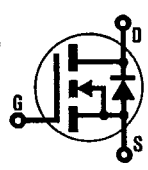


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HEXFET® TRANSISTORS \*JANTXV2N6764

JEDEC REGISTERED  
N-CHANNEL  
POWER MOSFETs



\*JANTX2N6764  
2N6764  
2N6763

\*QUALIFIED TO MIL-S-19500/543

100 Volt, 0.055 Ohm HEXFET

The HEXFET® technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of the HEXFET design achieve very low on-state resistance combined with high transconductance and great device ruggedness.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling, and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, and high energy pulse circuits.

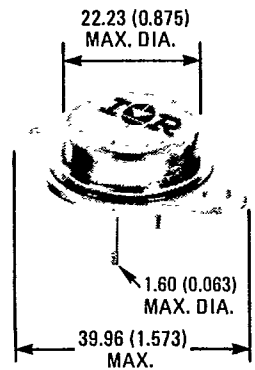
Features:

- Fast Switching
- Low Drive Current
- Ease of Paralleling
- Excellent Temperature Stability

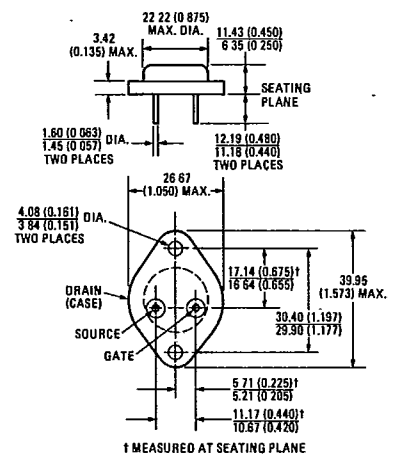
Product Summary

Part Number	V <sub>DS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
2N6763	60V	0.08Ω	31A
2N6764	100V	0.055Ω	38A

CASE STYLE AND DIMENSIONS



ACTUAL SIZE



Conforms to JEDEC Outline TO-204AE (Modified TO-3)  
Dimensions in Millimeters and (Inches)



JANTXV-, JANTX-, 2N6764 and 2N6763 Devices INTERNATIONAL RECTIFIER

Absolute Maximum Ratings

T-39-13

Parameter	2N6763	2N6764 *	Units
V <sub>DS</sub> Drain - Source Voltage	60*	100*	V
V <sub>DGR</sub> Drain - Gate Voltage (R <sub>GS</sub> = 1 MΩ)	60*	100*	V
I <sub>D</sub> @ T <sub>C</sub> = 25°C Continuous Drain Current	31*	38*	A
I <sub>D</sub> @ T <sub>C</sub> = 100°C Continuous Drain Current	20*	24*	A
I <sub>DM</sub> Pulsed Drain Current	60	70	A
V <sub>GS</sub> Gate - Source Voltage	±20*		V
P <sub>D</sub> @ T <sub>C</sub> = 25°C Max. Power Dissipation	150* (See Fig. 11)		W
P <sub>D</sub> @ T <sub>C</sub> = 100°C Max. Power Dissipation	60* (See Fig. 11)		W
Linear Derating Factor	1.2* (See Fig. 11)		W/K ②
I <sub>LM</sub> Inductive Current, Clamped	(See Fig. 1 and 2) L = 100 μH 60	70	A
T <sub>J</sub> Operating and Storage Temperature Range	-55* to 150*		°C
T <sub>stg</sub> Lead Temperature	300* (0.063 in. (1.6mm) from case for 10s)		°C


Electrical Characteristics @ T<sub>C</sub> = 25°C (Unless Otherwise Specified)

Parameter	Type	Min.	Typ.	Max.	Units	Test Conditions
BV <sub>DSS</sub> Drain - Source Breakdown Voltage	2N6763	60	-	-	V	V <sub>GS</sub> = 0
	2N6764	100	-	-	V	I <sub>D</sub> = 1.0 mA
V <sub>GS(th)</sub> Gate Threshold Voltage	ALL	2.0*	-	4.0*	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1 mA
I <sub>GSSF</sub> Gate - Body Leakage Forward	ALL	-	-	100*	nA	V <sub>GS</sub> = 20V
I <sub>GSSR</sub> Gate - Body Leakage Reverse	ALL	-	-	100*	nA	V <sub>GS</sub> = -20V
I <sub>DSS</sub> Zero Gate Voltage Drain Current	ALL	-	0.1	1.0*	mA	V <sub>DS</sub> = Max. Rating, V <sub>GS</sub> = 0
		-	0.2	4.0*	mA	V <sub>DS</sub> = Max. Rating, V <sub>GS</sub> = 0, T <sub>C</sub> = 125°C
V <sub>DS(on)</sub> Static Drain-Source On-State Voltage ①	2N6763	-	-	2.48*	V	V <sub>GS</sub> = 10V, I <sub>D</sub> = 31A
	2N6764	-	-	2.09*	V	V <sub>GS</sub> = 10V, I <sub>D</sub> = 38A
R <sub>DS(on)</sub> Static Drain-Source On-State Resistance ①	2N6763	-	0.06	0.08*	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A
	2N6764	-	0.045	0.055*	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 24A
R <sub>DS(on)</sub> Static Drain-Source On-State Resistance ①	2N6763	-	-	0.136*	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A, T <sub>C</sub> = 125°C
	2N6764	-	-	0.094*	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 24A, T <sub>C</sub> = 125°C
g <sub>fs</sub> Forward Transconductance ①	ALL	9.0*	12.5	27*	S (Ω)	V <sub>DS</sub> = 15V, I <sub>D</sub> = 24A
C <sub>iss</sub> Input Capacitance	ALL	1000*	2000	3000*	pF	V <sub>GS</sub> = 0, V <sub>DS</sub> = 25V, f = 1.0 MHz
C <sub>oss</sub> Output Capacitance	ALL	500*	1000	1500*	pF	See Fig. 10
C <sub>rss</sub> Reverse Transfer Capacitance	ALL	150*	350	500*	pF	
t <sub>d(on)</sub> Turn-On Delay Time	ALL	-	-	35*	ns	V <sub>DD</sub> ≅ 24V, I <sub>D</sub> = 24A, Z <sub>o</sub> = 4.7Ω
t <sub>r</sub> Rise Time	ALL	-	-	100*	ns	(See Figs. 13 and 14)
t <sub>d(off)</sub> Turn-Off Delay Time	ALL	-	-	125*	ns	(MOSFET switching times are essentially independent of operating temperature.)
t <sub>f</sub> Fall Time	ALL	-	-	100*	ns	

Thermal Resistance

R <sub>thJC</sub> Junction-to-Case	ALL	-	-	0.83*	K/W ②	
R <sub>thCS</sub> Case-to-Sink	ALL	-	0.1	-	K/W ②	Mounting surface flat, smooth, and greased.
R <sub>thJA</sub> Junction-to-Ambient	ALL	-	-	30	K/W ②	Typical socket mount

Body-Drain Diode Ratings and Characteristics

I <sub>S</sub> Continuous Source Current (Body Diode)	2N6763	-	-	31*	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier. 
	2N6764	-	-	38*	A	
I <sub>SM</sub> Pulsed Source Current (Body Diode)	2N6763	-	-	60	A	
	2N6764	-	-	70	A	
V <sub>SD</sub> Diode Forward Voltage ①	2N6763	0.90*	-	1.8*	V	T <sub>C</sub> = 25°C, I <sub>S</sub> = 31A, V <sub>GS</sub> = 0
	2N6764	0.95*	-	1.9*	V	T <sub>C</sub> = 25°C, I <sub>S</sub> = 38A, V <sub>GS</sub> = 0
t <sub>rr</sub> Reverse Recovery Time	ALL	-	500	-	ns	T <sub>J</sub> = 150°C, I <sub>F</sub> = I <sub>SM</sub> , dI <sub>F</sub> /dt = 100 A/μs
Q <sub>RR</sub> Reverse Recovered Charge	ALL	-	10	-	μC	T <sub>J</sub> = 150°C, I <sub>F</sub> = I <sub>SM</sub> , dI <sub>F</sub> /dt = 100 A/μs

\*JEDEC registered values. ① Pulse Test: Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%

② K/W = °C/W  
W/K = W/°C

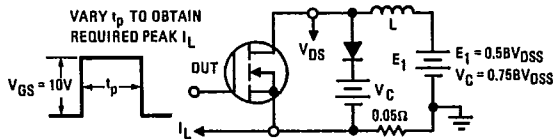


Fig. 1 - Clamped Inductive Test Circuit



Fig. 2 - Clamped Inductive Waveforms

JANTXV-, JANTX-, 2N6764 and 2N6763 Devices

INTERNATIONAL RECTIFIER T-39-13

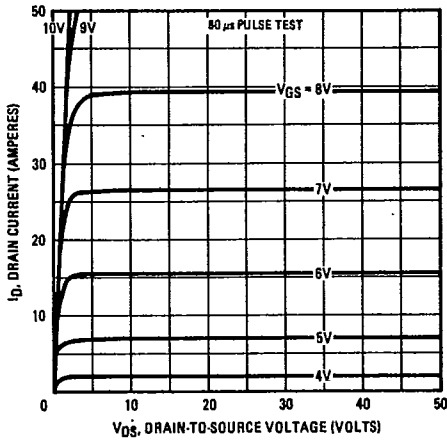


Fig. 3 - Typical Output Characteristics

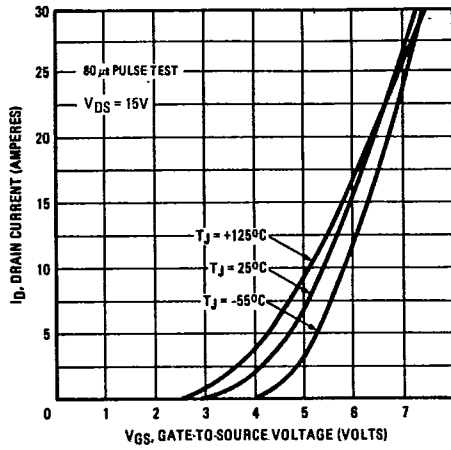


Fig. 4 - Typical Transfer Characteristics

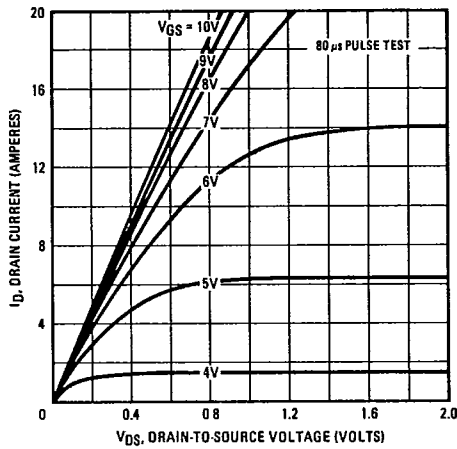


Fig. 5 - Typical Saturation Characteristics (2N6763)

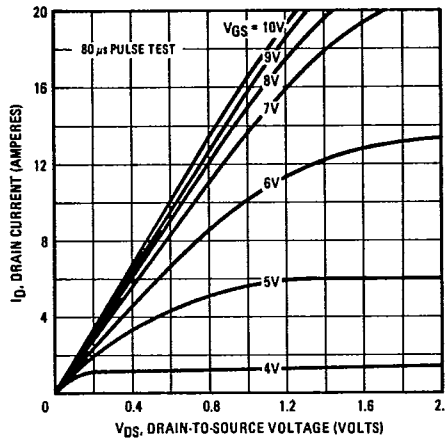


Fig. 6 - Typical Saturation Characteristics (2N6764)

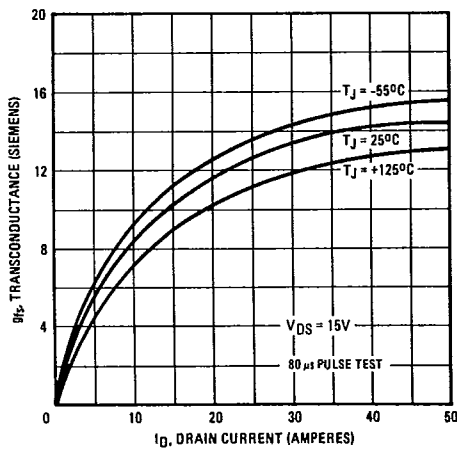


Fig. 7 - Typical Transconductance Vs. Drain Current

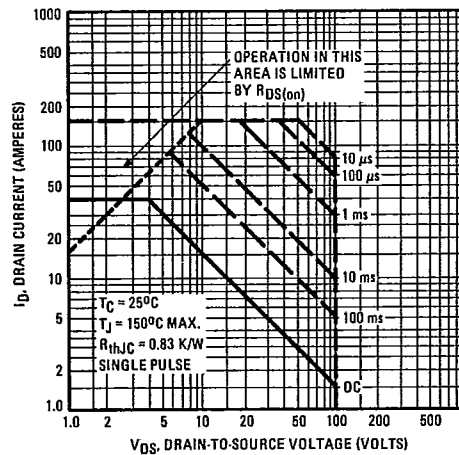


Fig. 8 - Maximum Safe Operating Area

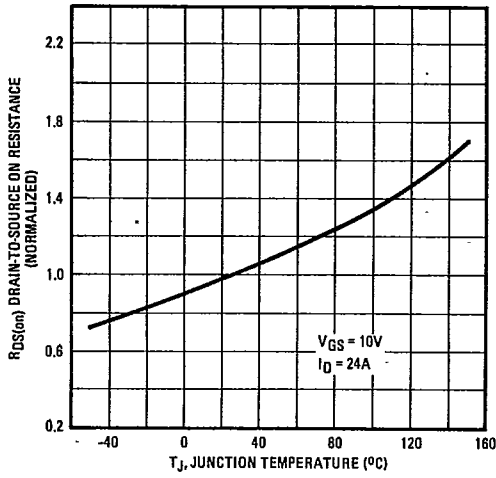


Fig. 9 - Normalized Typical On-Resistance Vs. Temperature

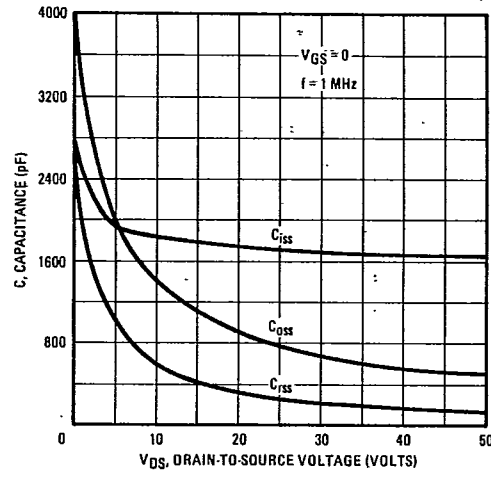


Fig. 10 - Typical Capacitance Vs. Drain-to-Source Voltage

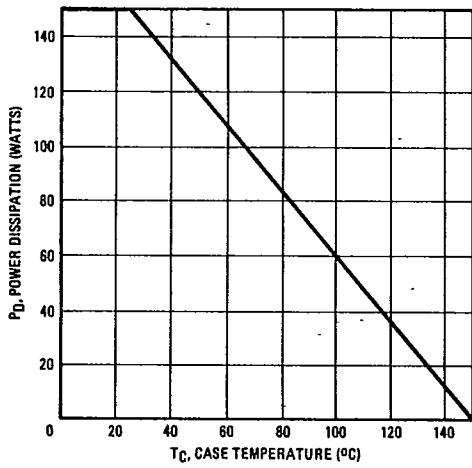


Fig. 11 - Power Vs. Temperature Derating Curve

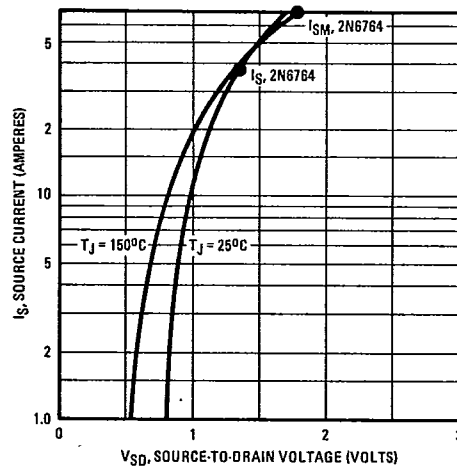


Fig. 12 - Typical Body-Drain Diode Forward Voltage

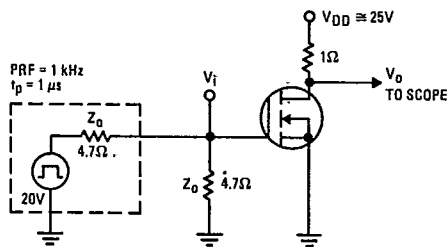


Fig. 13 - Switching Time Test Circuit

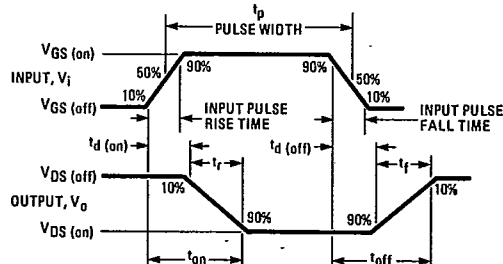


Fig. 14 - Switching Time Waveforms